

Operation: SMT&Push-Pull/短體式



LTEM NO.:TF-021B (Consumer Electronics)

(11.35L×5.50W×2.5H & T-Flash Sockets)

MEMORY-CARD-SOCKETS



Technical parameter

外焊貼裝 SMT

側向導入 LATERAL

超薄部品 NICETY

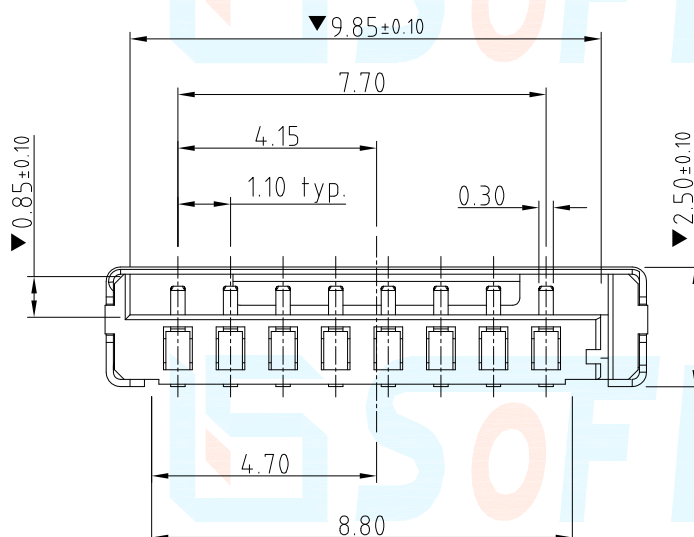
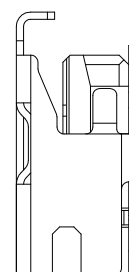
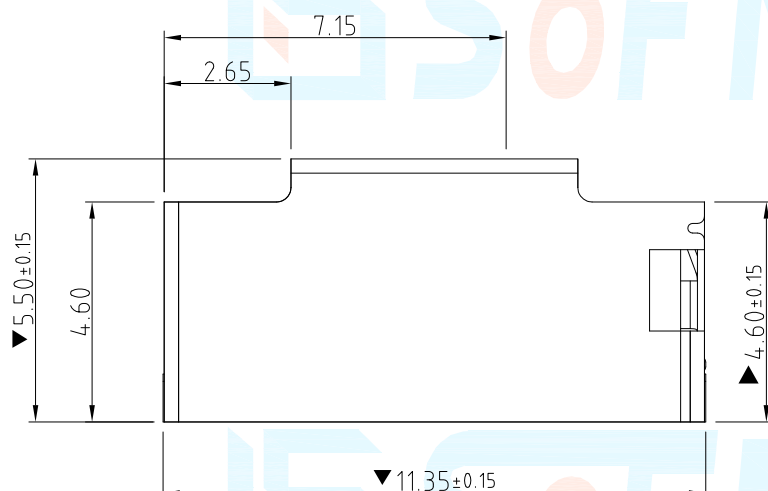
可靠 STABILIZE

適合環保 RoHS

PROJECT	LEVEL	A[better product]		B[average product]	
Electrical Properties	Contact Rating	25mA, 24V DC			
	Initial Contact Resistance	30mΩ max.		50mΩ max.	
	Insulation Resistance	100MΩ min.500V DC		Skey/PD: 100MΩ min.300V DC	
	Withstand Voltage	500V AC for 1 minute		350 V AC for 1 minut	
Durable Performance	There No Load	6,500 Cycles		5,500 Cycles	
	Rated Load	5,500 Cycles		4,500 Cycles	
	Storage temp.	-25℃～+75℃(Operating Temp:)			

Page1

Unit:mm



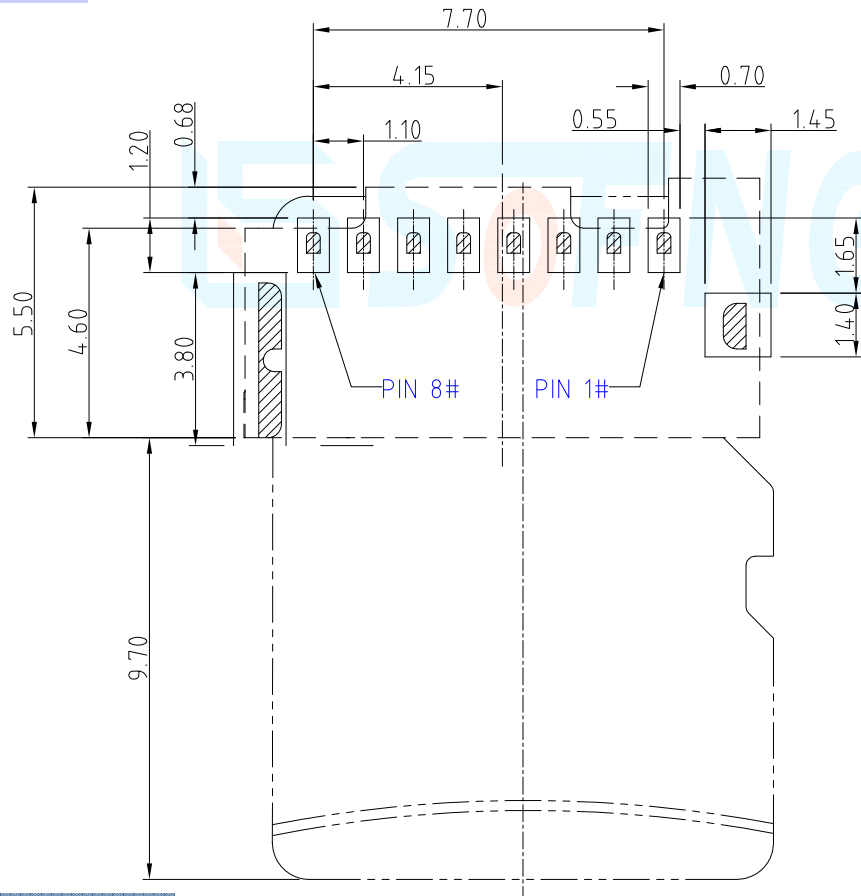
無檢測端子



Operating Force

Inward
Exiting

3. 0~4. 0N. (1N. =100gram-force)
4N. [±100gf]

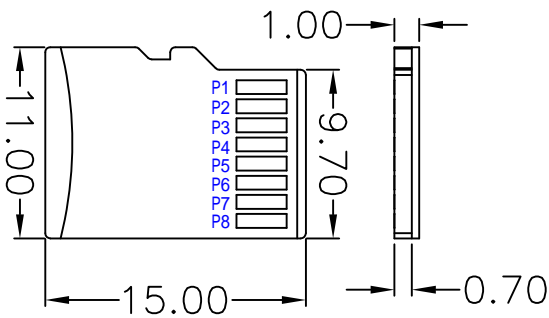


Pin definition



T-Flash CARD

Pin No.	Pin NAME	Type	Description
P①	DAT2	I/O/PP	Date Line[Bit 2]
P②	CD/DAT3	I/O/PP	Card Detect Date Lin(Bit 3)
P③	CMD	PP	Command Response
P④	VDD	S	Supply voltage
P⑤	CLX	I	Clock
P⑥	Vss	S	Supply voltage ground
P⑦	DAT 0	I/O/PP	Date Line [Bit 0]
P⑧	DAT 1	I/O/PP	Date Line [Dit 1]



T-Flash



注記 NOTICE

1. 碩方公司擁有最終解釋權；The SOFNG company reserves the right of final interpretation；
2. 文件禁止外洩、轉載；Leaked and reproduced prohibited；
3. 未經授權修改無效。Modify is invalid.

Material declaration

No.	NAME	MATERIAL	PLATING
① A	基座	LCP 30%G/F (Black)耐热塑胶	-
② B	接触端子	C5191R-H (t=0.15mm)磷青铜【锡 30u" 基镀金 1u"】	G/F
③ C	外壳	SUS301-3/4H(t=0.15mm)不锈钢【焊点镀金 1u"】	G/F
④ D	检测端子	C5191R-H (t=0.15mm)磷青铜【锡 30u" 基镀金 1u"】	G/F